

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VCX244FT, TC74VCX244FK

Low-Voltage Octal Bus Buffer with 3.6 V Tolerant Inputs and Outputs

The TC74VCX244 is a high performance CMOS octal bus buffer which is guaranteed to operate from 1.2 V to 3.6 V. Designed for use in 1.5 V, 1.8 V, 2.5 V or 3.3 V systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

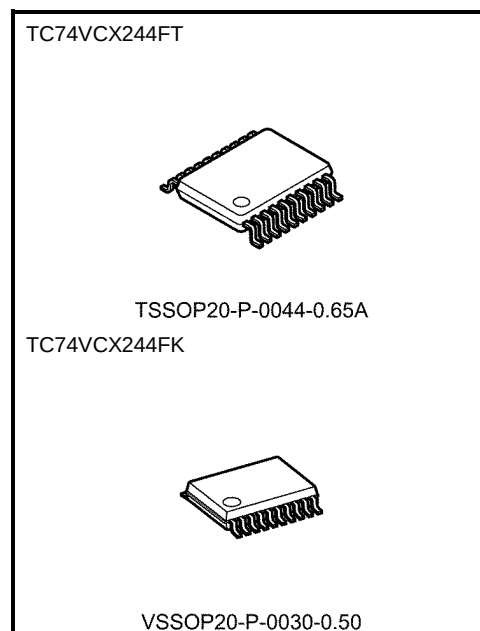
It is also designed with over voltage tolerant inputs and outputs up to 3.6 V.

This device is non-inverting 3-state buffer having two active-low output enables. When the $\overline{OE}$ input is high, the outputs are in a high impedance state. This device is designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge.

Features

- Low voltage operation: $V_{CC} = 1.2$ to 3.6 V
- High speed operation: $t_{pd} = 3.5$ ns (max) ($V_{CC} = 3.0$ to 3.6 V)
 $t_{pd} = 4.2$ ns (max) ($V_{CC} = 2.3$ to 2.7 V)
 $t_{pd} = 8.4$ ns (max) ($V_{CC} = 1.65$ to 1.95 V)
 $t_{pd} = 16.8$ ns (max) ($V_{CC} = 1.4$ to 1.6 V)
 $t_{pd} = 42.0$ ns (max) ($V_{CC} = 1.2$ V)
- Output current: $I_{OH}/I_{OL} = \pm 24$ mA (min) ($V_{CC} = 3.0$ V)
 $I_{OH}/I_{OL} = \pm 18$ mA (min) ($V_{CC} = 2.3$ V)
 $I_{OH}/I_{OL} = \pm 6$ mA (min) ($V_{CC} = 1.65$ V)
 $I_{OH}/I_{OL} = \pm 2$ mA (min) ($V_{CC} = 1.4$ V)
- Latch-up performance: -300 mA
- ESD performance: Machine model $\geq \pm 200$ V
Human body model $\geq \pm 2000$ V
- Package: TSSOP and VSSOP (US)
- 3.6 V tolerant inputs and outputs.
- Power down protection is provided on all inputs and outputs.



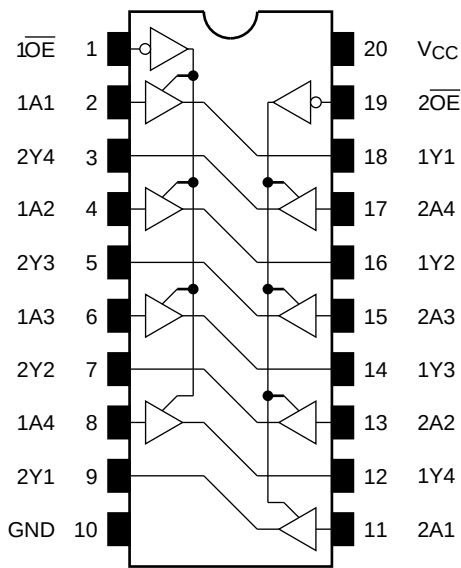
Weight

TSSOP20-P-0044-0.65A : 0.08 g (typ.)

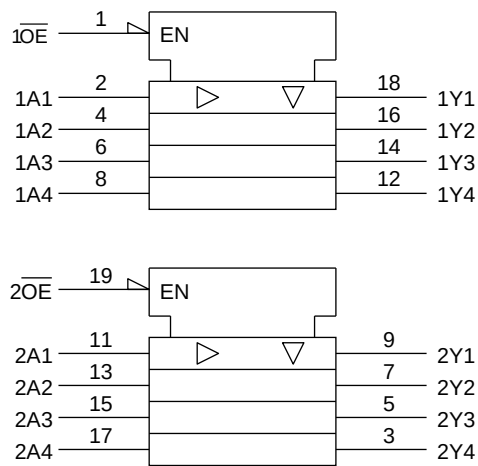
VSSOP20-P-0030-0.50 : 0.03 g (typ.)

Start of commercial production
1998-06

Pin Assignment (top view)



IEC Logic Level



Truth Table

Inputs		Outputs
$\overline{OE}$	A_n	
L	L	L
L	H	H
H	X	Z

X: Don't care

Z: High impedance

Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	-0.5 to 4.6	V
DC input voltage	V _{IN}	-0.5 to 4.6	V
DC output voltage	V _{OUT}	-0.5 to 4.6 (Note 1)	V
		-0.5 to V _{CC} + 0.5 (Note 2)	
Input diode current	I _{IK}	-50	mA
Output diode current	I _{OK}	±50 (Note 3)	mA
DC output current	I _{OUT}	±50	mA
Power dissipation	P _D	180	mW
DC V _{CC} /ground current	I _{CC} /I _{GND}	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Off-state

Note 2: High or low state. I_{OUT} absolute maximum rating must be observed.

Note 3: V_{OUT} < GND, V_{OUT} > V_{CC}

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	1.2 to 3.6	V
Input voltage	V _{IN}	-0.3 to 3.6	V
Output voltage	V _{OUT}	0 to 3.6 (Note 1)	V
		0 to V _{CC} (Note 2)	
Output current	I _{OH} /I _{OL}	±24 (Note 3)	mA
		±18 (Note 4)	
		±6 (Note 5)	
		±2 (Note 6)	
Operating temperature	T _{opr}	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device.
Unused inputs must be tied to either V_{CC} or GND.

Note 1: Off-state

Note 2: High or low state

Note 3: V_{CC} = 3.0 to 3.6 V

Note 4: V_{CC} = 2.3 to 2.7 V

Note 5: V_{CC} = 1.65 to 1.95 V

Note 6: V_{CC} = 1.4 to 1.6 V

Note 7: V_{IN} = 0.8 to 2.0 V, V_{CC} = 3.0 V

Electrical Characteristics

DC Characteristics (Ta = -40 to 85°C, 2.7 V < Vcc ≤ 3.6 V)

Characteristics		Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
Input voltage	High level	V _{IH}	—		2.7 to 3.6	2.0	—	V
	Low level	V _{IL}	—		2.7 to 3.6	—	0.8	
Output voltage	High level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -100 μA	2.7 to 3.6	V _{CC} - 0.2	—	V
				I _{OH} = -12 mA	2.7	2.2	—	
				I _{OH} = -18 mA	3.0	2.4	—	
				I _{OH} = -24 mA	3.0	2.2	—	
	Low level	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	2.7 to 3.6	—	0.2	
				I _{OL} = 12 mA	2.7	—	0.4	
				I _{OL} = 18 mA	3.0	—	0.4	
				I _{OL} = 24 mA	3.0	—	0.55	
Input leakage current		I _{IN}	V _{IN} = 0 to 3.6 V	2.7 to 3.6	—	±5.0	μA	
3-state output off-state current		I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = 0 to 3.6 V	2.7 to 3.6	—	±10.0	μA	
Power off leakage current		I _{OFF}	V _{IN} , V _{OUT} = 0 to 3.6 V	0	—	10.0	μA	
Quiescent supply current		I _{CC}	V _{IN} = V _{CC} or GND	2.7 to 3.6	—	20.0	μA	
			V _{CC} ≤ (V _{IN} , V _{OUT}) ≤ 3.6 V	2.7 to 3.6	—	±20.0		
		ΔI _{CC}	V _{IH} = V _{CC} - 0.6 V (per input)	2.7 to 3.6	—	750		

DC Characteristics (Ta = -40 to 85°C, 2.3 V ≤ Vcc ≤ 2.7 V)

Characteristics		Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
Input voltage	High level	V _{IH}	—		2.3 to 2.7	1.6	—	V
	Low level	V _{IL}	—		2.3 to 2.7	—	0.7	
Output voltage	High level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -100 μA	2.3 to 2.7	V _{CC} - 0.2	—	V
				I _{OH} = -6 mA	2.3	2.0	—	
				I _{OH} = -12 mA	2.3	1.8	—	
				I _{OH} = -18 mA	2.3	1.7	—	
	Low level	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	2.3 to 2.7	—	0.2	
				I _{OL} = 12 mA	2.3	—	0.4	
				I _{OL} = 18 mA	2.3	—	0.6	
Input leakage current		I _{IN}	V _{IN} = 0 to 3.6 V	2.3 to 2.7	—	±5.0	μA	
3-state output off-state current		I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = 0 to 3.6 V	2.3 to 2.7	—	±10.0	μA	
Power off leakage current		I _{OFF}	V _{IN} , V _{OUT} = 0 to 3.6 V	0	—	10.0	μA	
Quiescent supply current		I _{CC}	V _{IN} = V _{CC} or GND	2.3 to 2.7	—	20.0	μA	
			V _{CC} ≤ (V _{IN} , V _{OUT}) ≤ 3.6 V	2.3 to 2.7	—	±20.0		

DC Characteristics (Ta = -40 to 85°C, 1.65 V ≤ Vcc < 2.3 V)

Characteristics		Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
Input voltage	High level	V _{IH}	—		1.65 to 2.3	0.65 × V _{CC}	—	V
	Low level	V _{IL}	—		1.65 to 2.3	—	0.2 × V _{CC}	
Output voltage	High level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -100 μA	1.65 to 2.3	V _{CC} - 0.2	—	V
				I _{OH} = -6 mA	1.65	1.25	—	
	Low level	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	1.65 to 2.3	—	0.2	
				I _{OL} = 6 mA	1.65	—	0.3	
Input leakage current		I _{IN}	V _{IN} = 0 to 3.6 V		1.65 to 2.3	—	±5.0	μA
3-state output off-state current		I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = 0 to 3.6 V		1.65 to 2.3	—	±10.0	μA
Power off leakage current		I _{OFF}	V _{IN} , V _{OUT} = 0 to 3.6 V		0	—	10.0	μA
Quiescent supply current		I _{CC}	V _{IN} = V _{CC} or GND		1.65 to 2.3	—	20.0	μA
			V _{CC} ≤ (V _{IN} , V _{OUT}) ≤ 3.6 V		1.65 to 2.3	—	±20.0	

DC Characteristics (Ta = -40 to 85°C, 1.4 V ≤ Vcc < 1.65 V)

Characteristics		Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
Input voltage	High level	V _{IH}	—		1.4 to 1.65	0.65 × V _{CC}	—	V
	Low level	V _{IL}	—		1.4 to 1.65	—	0.05 × V _{CC}	
Output voltage	High level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -100 μA	1.4 to 1.65	V _{CC} - 0.2	—	V
				I _{OH} = -2 mA	1.4	1.05	—	
	Low level	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	1.4 to 1.65	—	0.05	
				I _{OL} = 2 mA	1.4	—	0.35	
Input leakage current		I _{IN}	V _{IN} = 0 to 3.6 V		1.4 to 1.65	—	±5.0	μA
3-state output off-state current		I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = 0 to 3.6 V		1.4 to 1.65	—	±10.0	μA
Power off leakage current		I _{OFF}	V _{IN} , V _{OUT} = 0 to 3.6 V		0	—	10.0	μA
Quiescent supply current		I _{CC}	V _{IN} = V _{CC} or GND		1.4 to 1.65	—	20.0	μA
			V _{CC} ≤ (V _{IN} , V _{OUT}) ≤ 3.6 V		1.4 to 1.65	—	±20.0	

DC Characteristics (Ta = -40 to 85°C, 1.2 V ≤ Vcc < 1.4 V)

Characteristics		Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
Input voltage	High level	V _{IH}	—		1.2 to 1.4	0.80 × V _{CC}	—	V
	Low level	V _{IL}	—		1.2 to 1.4	—	0.05 × V _{CC}	V
Output voltage	High level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -100 μA	1.2	V _{CC} - 0.1	—	V
	Low level	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	1.2	—	0.05	V
Input leakage current		I _{IN}	V _{IN} = 0 to 3.6 V		1.2	—	±5.0	μA
3-state output off-state current		I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = 0 to 3.6 V		1.2	—	±10.0	μA
Power off leakage current		I _{OFF}	V _{IN} , V _{OUT} = 0 to 3.6 V		0	—	10.0	μA
Quiescent supply current		I _{CC}	V _{IN} = V _{CC} or GND		1.2	—	20.0	μA
			V _{CC} ≤ (V _{IN} , V _{OUT}) ≤ 3.6 V		1.2	—	±20.0	

AC Characteristics (Note) (Ta = -40 to 85°C, Input: tr = tf = 2.0 ns)

Characteristics		Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
Propagation delay time	t _{pLH} t _{pHL}	Figure 1, Figure 2	CL = 15 pF, RL = 2 kΩ		1.2	3.0	42.0	ns
					1.5 ± 0.1	2.0	16.8	
			CL = 30 pF, RL = 500 Ω		1.8 ± 0.15	1.5	8.4	
					2.5 ± 0.2	0.8	4.2	
3-state output enable time	t _{pZL} t _{pZH}	Figure 1, Figure 3	CL = 15 pF, RL = 2 kΩ		1.2	3.0	49.0	ns
					1.5 ± 0.1	2.0	19.6	
			CL = 30 pF, RL = 500 Ω		1.8 ± 0.15	1.5	9.8	
					2.5 ± 0.2	0.8	5.5	
3-state output disable time	t _{pLZ} t _{pHZ}	Figure 1, Figure 3	CL = 15 pF, RL = 2 kΩ		1.2	3.0	29.0	ns
					1.5 ± 0.1	2.0	11.6	
			CL = 30 pF, RL = 500 Ω		1.8 ± 0.15	1.5	5.8	
					2.5 ± 0.2	0.8	3.2	
Output to output skew	t _{osLH} t _{osHL}	(Note 1)	CL = 15 pF, RL = 2 kΩ		1.2	—	1.5	ns
					1.5 ± 0.1	—	1.5	
			CL = 30 pF, RL = 500 Ω		1.8 ± 0.15	—	0.5	
					2.5 ± 0.2	—	0.5	
					3.3 ± 0.3	0.6	3.0	
					3.3 ± 0.3	0.6	3.0	

Note: For C_L = 50 pF, add approximately 300 ps to the AC maximum specification.

Note 1: This parameter is guaranteed by design.

(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)

Switching Characteristics (Note) (Ta = 25°C, Input: tr = tr = 2.0 ns, CL = 30 pF)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Typ.	Unit
Quiet output maximum dynamic VOL	VOLP	V _{IH} = 1.8 V, V _{IL} = 0 V	1.8	0.25	V
		V _{IH} = 2.5 V, V _{IL} = 0 V	2.5	0.6	
		V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.8	
Quiet output minimum dynamic VOL	VOLV	V _{IH} = 1.8 V, V _{IL} = 0 V	1.8	-0.25	V
		V _{IH} = 2.5 V, V _{IL} = 0 V	2.5	-0.6	
		V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	-0.8	
Quiet output minimum dynamic VOH	VOHV	V _{IH} = 1.8 V, V _{IL} = 0 V	1.8	1.5	V
		V _{IH} = 2.5 V, V _{IL} = 0 V	2.5	1.9	
		V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	2.2	

Note: This parameter is guaranteed by design.

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Typ.	Unit
Input capacitance	C _{IN}	—	1.8, 2.5, 3.3	6	pF
Output capacitance	C _O	—	1.8, 2.5, 3.3	7	pF
Power dissipation capacitance	CPD	f _{IN} = 10 MHz (Note 1)	1.8, 2.5, 3.3	20	pF

Note 1: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC}(\text{opr}) = CPD \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

AC Test Circuit

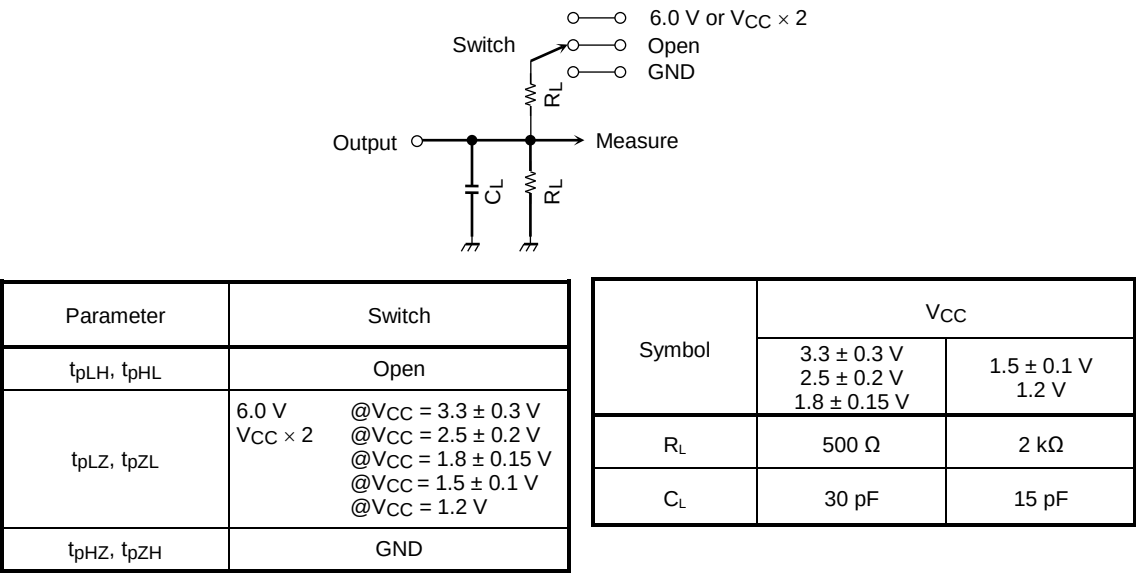


Figure 1 AC Test Circuit

AC Waveform

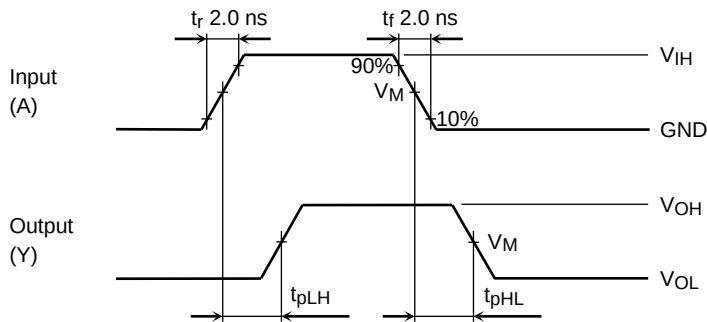


Figure 2 t_{pLH} , t_{pHL}

Symbol	Vcc				
	3.3 ± 0.3 V	2.5 ± 0.2 V	1.8 ± 0.15 V	1.5 ± 0.1 V	1.2 V
VIH	2.7 V	Vcc	Vcc	Vcc	Vcc
VM	1.5 V	Vcc/2	Vcc/2	Vcc/2	Vcc/2

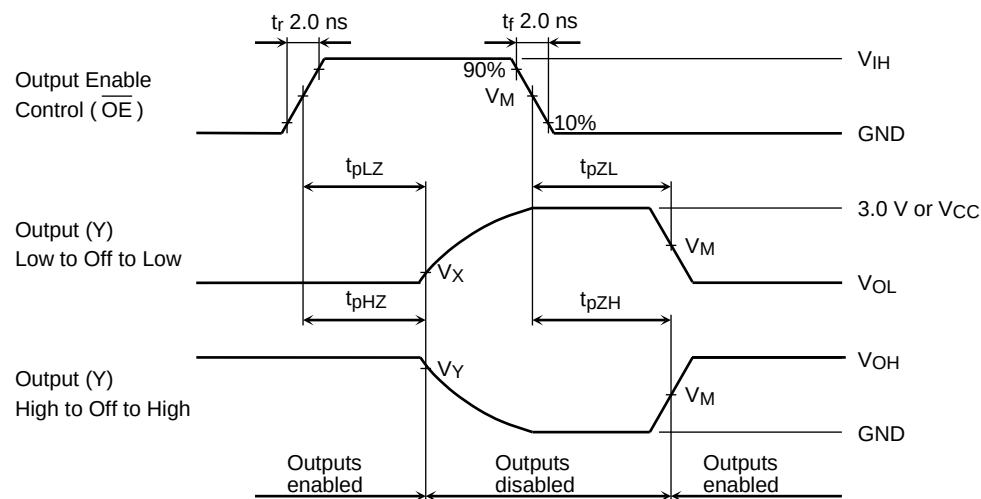


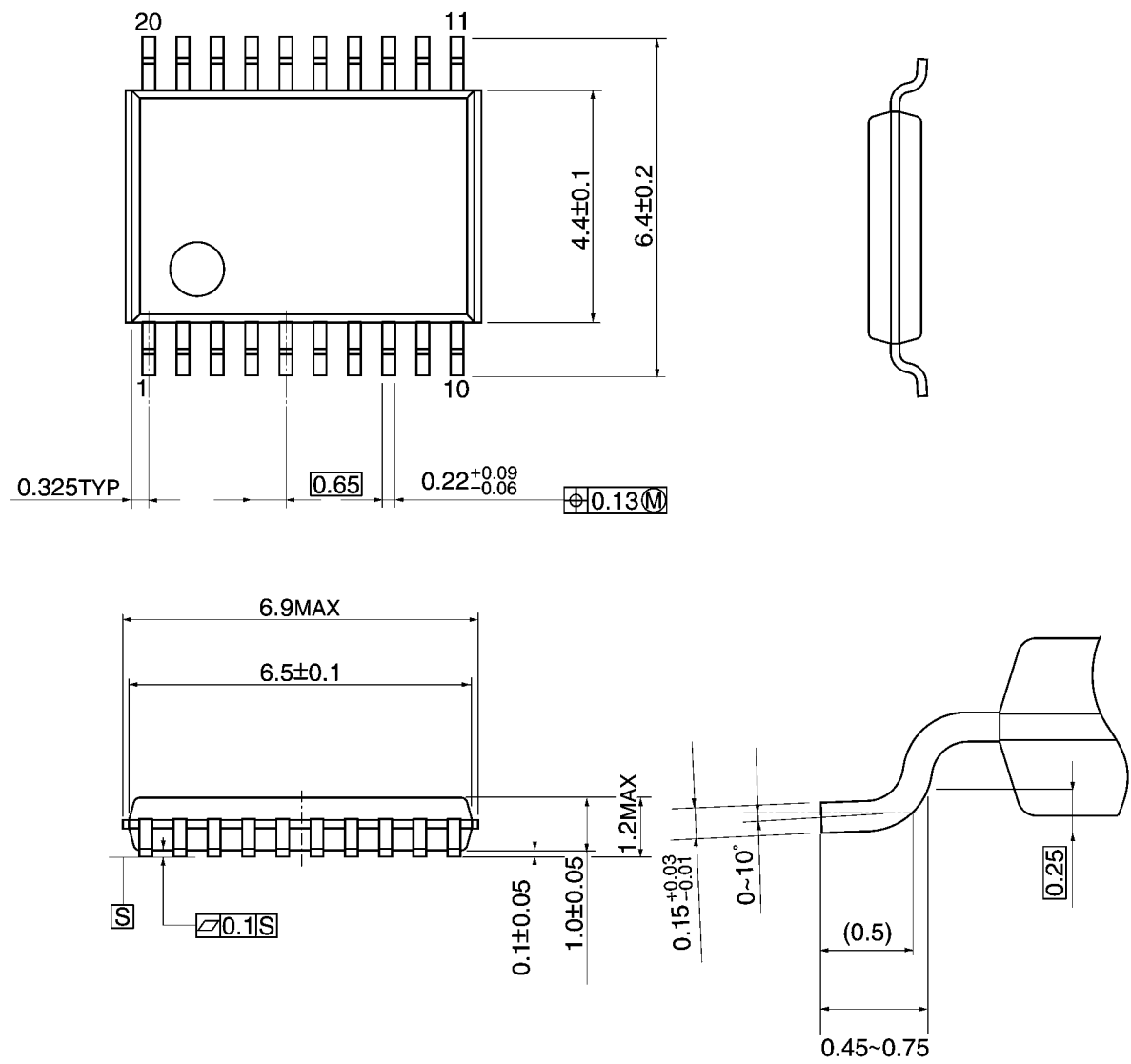
Figure 3 t_{pLZ} , t_{pHZ} , t_{pZL} , t_{pZH}

Symbol	VCC				
	3.3 ± 0.3 V	2.5 ± 0.2 V	1.8 ± 0.15 V	1.5 ± 0.1 V	1.2 V
V_{IH}	2.7 V	V_{CC}	V_{CC}	V_{CC}	V_{CC}
V_M	1.5 V	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$	$V_{CC}/2$
V_X	$V_{OL} + 0.3 V$	$V_{OL} + 0.15 V$	$V_{OL} + 0.15 V$	$V_{OL} + 0.1 V$	$V_{OL} + 0.1 V$
V_Y	$V_{OH} - 0.3 V$	$V_{OH} - 0.15 V$	$V_{OH} - 0.15 V$	$V_{OH} - 0.1 V$	$V_{OH} - 0.1 V$

Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm

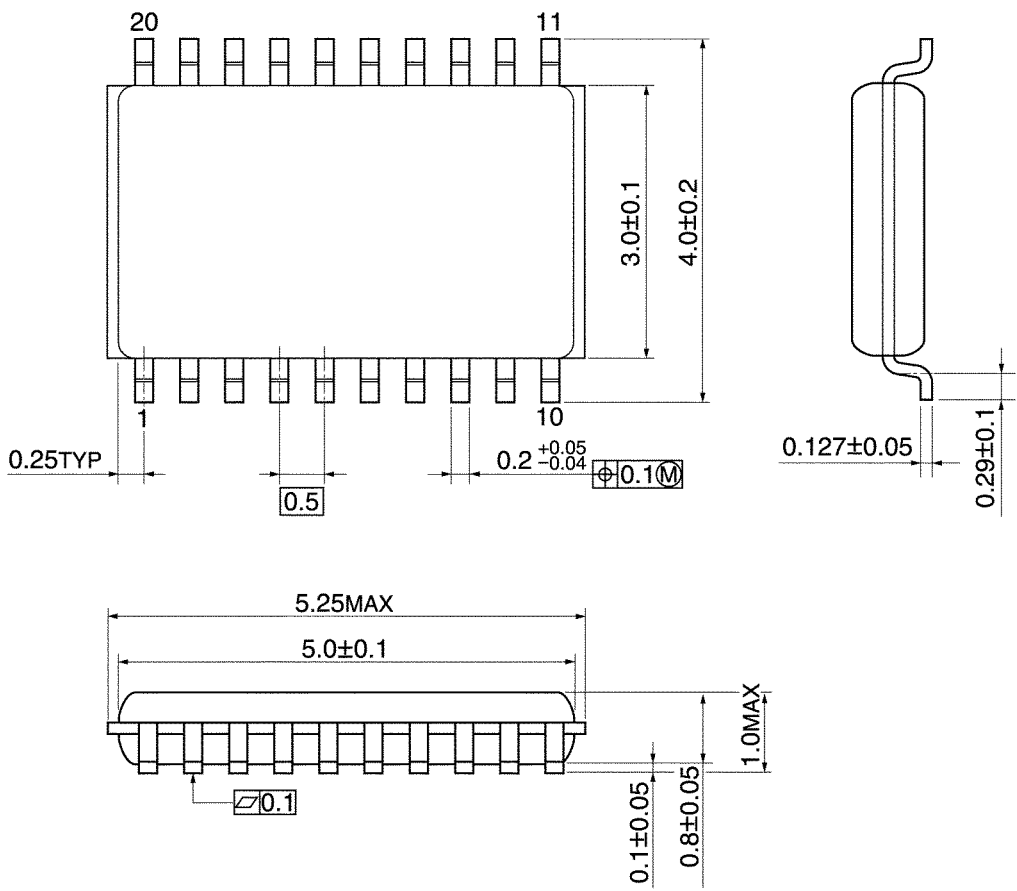


Weight: 0.08 g (typ.)

Package Dimensions

VSSOP20-P-0030-0.50

Unit: mm



Weight: 0.03 g (typ.)

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